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1.1 General Description

AP3917B is an off-line universal AC Voltage input step-down regulator that provides accurate constant voltage (CV), outstanding low standby power, light loading efficiency and dynamics performance. The chip supports non-isolated buck and buck-boost topology, and also isolated and non-isolated flyback topology. The main applications are for cost-effective home appliance power.

Working with a single winding inductor and integrating a 650V MOSFET when used in buck topology, the BOM cost is very low.

The AP3917B EV3 Evaluation Board contains two outputs specifications: 12V20mA and 3.8V20mA, with both non-isolations flyback. The two outputs share a three-winding transformer. The feedback circuitry samples 3.8V output. The user's guide provides good design example for dual output power applications in home appliance power.

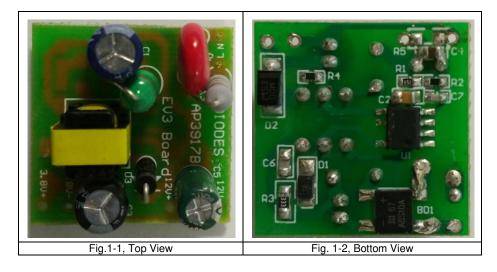
1.2 AP3917B Key Features

- Universal 85V to 264V V_{AC} Input
- Internal MOSFET 650V (Rds(on) 10Ω max. @25°C)
- Maximum output Current: 170mA typ.@5V output
- Low Standby Power Consumption
- · High Light Loading Efficiency and average efficiency can meet DOE IV and CoC V5 Tier
- 2
 - Frequency Modulation to suppress EMI to meet EN55032 and FCC part 15 class B
- Rich Protection including: OTP, OLP, OLD, SCP
- Extremely low system component count.
- Totally Lead-free & Fully RoHS Compliant (SO-7)
- Halogen and Antimony Free. "Green" Device

1.3 Applications

- Non-Isolated Home Appliances including: AC Fans, Rice Cooker, Air conditioner, Coffee Machines, Soy Milk Machines, ect.
- Auxiliary Power to IoT Devices.

1.4 Board Picture





Chapter2 Power Supply Specification

2.1 system performance

The system performance included in and output characters, specifications, EMC, protection, ect.

lte	Items Min.		Тур.	Max.	Comments
		•	input characte	ers	•
Input AC voltage rating		100V/60Hz	115/230	240V/50Hz	
Input AC v	oltage range	85V/60Hz	-	264V/50Hz	Two wire, no PE
Input AC fre	quency range	47Hz	50/60	63Hz	
		•	Output charact	ers	
Output	voltage 1	11.1V	12.0V	12.9V	Test at board terminal
Output	voltage 1	3.61V	3.8V	3.99V	
loading	current 1	0	-	20mA	mA
loading	current 2	4	-	20mA	
		ре	rformance specif	ications	
Stand	by power	-		12mW	@230V/50Hz
Effic	Efficiency		74.32%/72.98%	-	@full load, 115V/230V
Ripple & Noise 12V	se 12V	-	192mV	220mV	
	3.8V	-	101mV	150mV	@full load
Start	up time	-	16.8ms	20ms	@full load, 85V/60Hz
			EMC test		
ESD test	Air	±15kV	-	-	
	contract	±8kV	-	-	@full load condition
Surg	e Test	±0.5kV	-	-	Differential mode, 20hm, 1.2/50us
Conduction	110V	6dB margin	-	-	FCC Part 15 Class B
EMI	230V	6dB margin	-	-	EN55032
			Protection func	tion	
SCF	P test	-	-	-	ОК
OLF	P test	-	-	-	ОК
OTF	P test	135°C	150°C	165°C	ОК

2.2 Environment

Operation temperature: -20°C~85°C Operation Humidity: 20%~90% R.H. Storage temperature: 0~40°C Storage Humidity: 0%~95% R.H.



Chapter3 Schematic and bill of material

3.1 Schematic

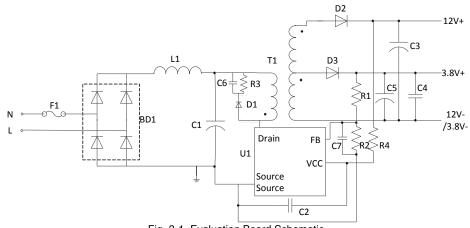


Fig. 3-1, Evaluation Board Schematic

3.2 Bill of Material

I able 3-1, bill of material						
Item	Designator	Description	Footprint	Qty.	Manufacturer	
1	F1	8.2R, fusible resistor	Ф3*10mm	1	OAHE	
2	BD1	ABS10A, bridge diode	SOPA-4	1	Diodes	
3	C1	2.2uF/400V, electrolytic capacitor	Ф6*9mm	1	Aishi	
4	C2	2.2uF/25V, X7R	SMD 0805	1	Telesky	
5	C3	100uF/16V, electrolytic capacitor	Ф6*7mm	1	Aishi	
6	C4	10uF/16V, X7R	SMD 0805	1	Telesky	
7	C5	22uF/16V, electrolytic capacitor	Ф5*10mm	1	Telesky	
8	C6	470pF/500V, X7R	SMD 0805	1	Telesky	
9	C7	470pF/50V, X7R	SMD 0805	1	Telesky	
10	D1	S1MWF-7, slow type diode, mark F9	SOD123-FL	1	Diodes	
11	D2	ES1J, 1A/600V, Trr 35ns	SMA	1	Diodes	
12	D3	APD260, Schottky diode, 2A/60V	DO-41	1	Diodes	
13	L1	2.2mH,choke inductor	DIP, 0406	1	Deloop	
14	T1	EE8.3, Horizontal	DIP, 3+3Pin, Horizontal	1	Deloop	
15	R1	24.7k, thick film	SMD 0805, 1%	1	Panasonic	
16	R2	13.0k, thick film	SMD 0805, 1%	1	Panasonic	
17	R3	330k, thick film	SMD 0805, 5%	1	Panasonic	
18	R4	27k, thick film	SMD 0805, 5%	1	Panasonic	
19	U1	AP3917B SO-7 1 Diodes				
t	otal	19pcs				

Table 3-1, bill of material



3.3 Transformer Specification

3.3.1 Electrical Diagram

Bobbin: EE8.3, 3+3Pin, Horizontal Core: PC40, Ae=7mm²

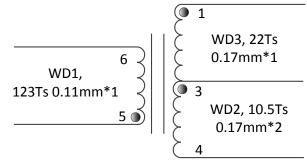


Fig. 3-2, transformer electrical diagram

3.3.2 Transformer Instructions

Winding	Wire	Turns	Notes
5-6	0.11mm*1 UEW	123	three layer with tight tension
Таре	W=5mm	2	Full layer
3-4	0.17mm*2 UEW	10.5	One layer with tight tension
Таре	W=5mm	2	Full layer
1-3	0.17mm*1 UEW	23	One layer with tight tension
Tape	W=7mm	2	Full layer

Note: the transformer need be varnished. Put the transformer in the varnish for 30min, then remove it to the oven at 90°C for at least 6 hours.

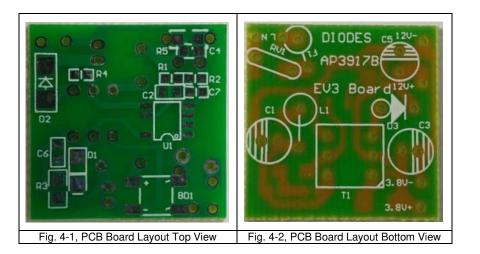
3.3.3 Electrical Specifications

Item	Pins	Inductance	Conditions
Main inductance	5-6	800uH±7%	1/3/4pin open, 1V/10kHz
Leak inductance	5-6	<50uH	1/3/4pin short, 1V/10kHz

Chapter4 Evaluation Board Connections

4.1 PCB Layout





4.2 Circuit Description

4.2.1 Input EMI Filtering

The input stage is composed of fusible resistor RF1, bridge diodes (BD1), Capacitors C1 and inductor L1. Resistor RF1 is a flame proof, fusible, wire-wound resistor. It limits inrush current to safe levels for bridge diodes, provides differential mode noise reduction and acts as an input fuse in the event of short circuit. Inductor L1 and Capacitor C1 constitute a LC filter, which can smooth the input voltage and improve EMI conduction.

4.2.2 Control IC

AP3917B co-packages a 650V power MOSFET and control circuitry into a cost-effective SO-8 package. The device gets its start-up current from DRAIN pin with a small capacitor C3 connect to BP pin when AC source is applied.

4.2.3 Flyback block

The flyback system which coupled in a transformer contains two output, 12V and 3.8V. The 3.8V output winding and 12V output winding are in series, so if the turn ratio of 12V winding to 3.8V winding approximate to 12/3.8, the output voltage can be fixed to 12V and 3.8V.

4.2.4 Output Rectification

During the ON time of U1, current ramps in the main inductance of transformer T1 until the current reaches to the lpk. During the OFF time the inductor current ramps down via diodes D2 and D3. D2 andD3 must be ultra-fast diode or schottky diode (Trr<50ns or lower). Capacitor C3/C5 should be selected to have an adequate ripple margin.

4.2.5 Output Feedback

The voltage across C4/C5 is quite smooth, so the divider R1 and R2 can reflect the output voltage. The output voltage dividend by R1 and R2 was sent to feedback pin to regulate the 3.8V output voltage, thus regulate the 12V output voltage. A small capacitor C7 about several hundreds of pF was used to prevent sharp noise of sampling circuit.

4.3 Quick Start Guide

- 1. The evaluation board is preset at 12V/20mA+3.8V20mA from output.
- 2. Ensure that the AC source is switched OFF or disconnected before doing connection.
- 3. Connect the AC line wires of power supply to "L and N" on the left side of the board.
- 4. Turn on the AC main switch.
- 5. Measure output terminals to ensure correct output voltages of Vo1 and Vo2 respectively.



5.1 Input & Output Characteristics

5.1.1 Input Standby Power

The standby power and output voltage was tested after 10min burning. The voltage data was tested at the PCB terminal. All the data was tested at room temperature.

Input Voltage	Pin (mW)	Vo1 (V)	Vo2 (V)
85V/60Hz	5.0	3.791	12.202
115V/60Hz	5.4	3.791	12.205
230V/50Hz	7.8	3.788	12.197
264V/50Hz	8.6	3.788	12.197

Table 5-1, standby power and no load output voltage

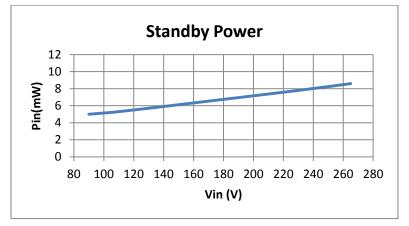


Fig. 5-1, Standby Power versus Vin Curve

5.1.2 Efficiency

The efficiency data was tested after 10min burning, and it was tested at the PCB terminal. All the data was tested at room temperature. 12V and 3.8V full load, input voltage range from 85V/60Hz to 265V/50Hz.

	,			
Vin	Vo1(V)	Vo2(V)	Pin(W)	Eff.
85V/60Hz	3.752	12.291	0.451	73.22%
115V/60Hz	3.746	12.280	0.452	72.98%
150V/60Hz	3.749	12.282	0.444	74.32%
180V/50Hz	3.748	12.280	0.446	73.97%
200V/50Hz	3.748	12.280	0.447	73.80%
230V/50Hz	3.746	12.280	0.452	72.98%
265V/50Hz	3.746	12.278	0.460	71.70%

Table 5-2, Full load efficiency VS Vin data



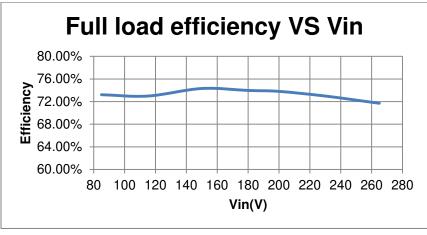


Fig. 5-2, Full load efficiency VS Vin

5.1.3 Line Regulation

The line regulation data was tested after 10min burning. The voltage data was tested at the PCB terminal. All the data was tested at room temperature. 3.8V and 12V full load, Vin ranges from 85V to 264V.

	-	
Vin	Vo1 output(V)	Vo2 output (V)
Vin	Vo1(V)	Vo2(V)
85V/60Hz	3.752	12.291
115V/60Hz	3.746	12.280
150V/60Hz	3.749	12.282
180V/50Hz	3.748	12.280
200V/50Hz	3.748	12.280
230V/50Hz	3.746	12.280
265V/50Hz	3.746	12.278

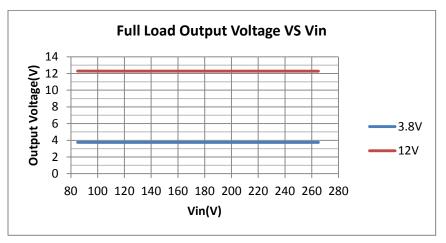
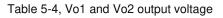


Fig 5-3, 3.8V and 12V full load, output voltage versus input voltag



The load regulation data was tested after 10min burning. The voltage data was tested at the PCB terminal. All the data was tested at room temperature. The load of Vo1 and Vo2 terminals both ranges from 10% to 100%.

Vin	10	%	25	5%	50	1%	75	%	10	0%
	Vo1(V)	Vo2(V)								
85V/60Hz	3.788	11.578	3.785	11.772	3.788	11.937	3.772	12.057	3.768	12.157
115V/60Hz	3.788	11.585	3.784	3.777	3.774	11.932	3.772	12.052	3.766	12.157
230V/50Hz	3.786	11.572	3.781	11.757	3.774	11.922	3.769	12.047	3.764	12.147
265V/50Hz	3.785	11.572	3.780	11.755	3.774	11.922	3.768	12.045	3.763	12.147



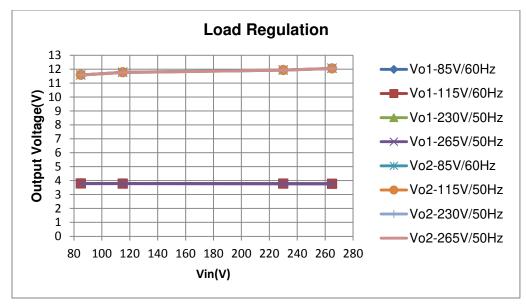


Fig. 5-4, 12V and 5V output voltage@ 3.8V no load

5.2 Key Performance test

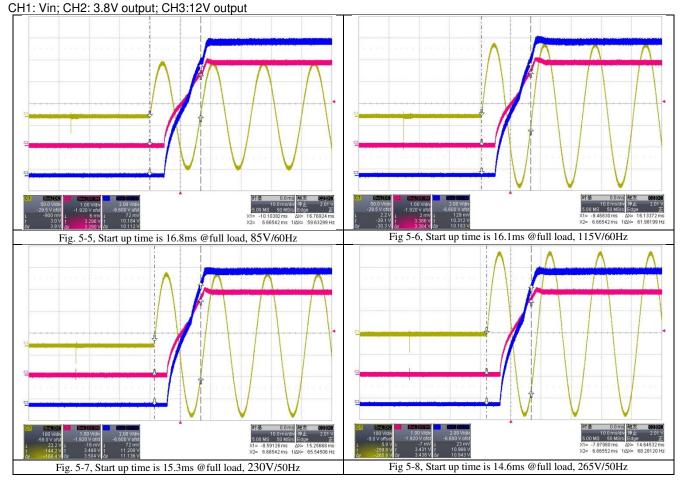
5.2.1 Start up performance

The start-up time was measured with differential probe clipping on the input AC source, and the common low-voltage probe clipping on the output terminal. Before start-up, the buck cap should be discharged.

Input voltage	Start up time	figures
85V/60Hz	16.8ms	Fig. 15
115V/50Hz	16.1ms	Fig. 16
230V/50Hz	15.3ms	Fig. 17
264V/60Hz	14.6ms	Fig. 18

Table 5-5,	start	up perforr	nance
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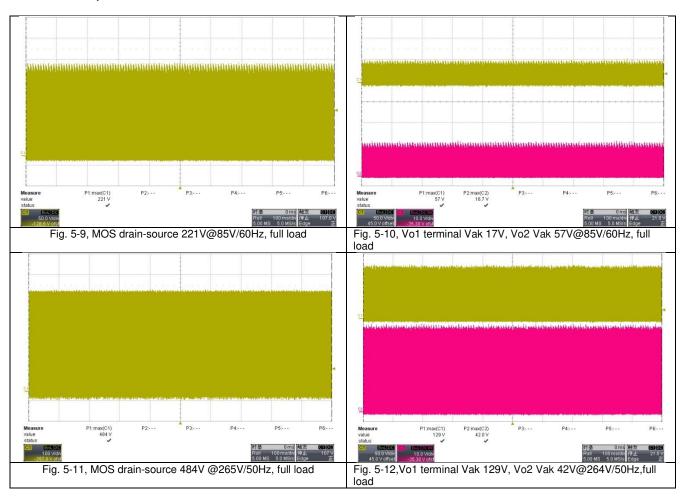
5.2.2 Voltage Stress

The voltage tested below was between the source and the drain pin of IC. The test need use differential probe. The Vak voltage is tested between the anode and cathode of flyback diode D2/D3.

Table 5-6, MOSFET drain-source	and flyback diodes	Vak voltage stress
	and hybrack aloues	van vonage stress

line ut velte se		<i>t</i> :		
Input voltage	Vds(V)	Vak1(V)	Vak2(V)	figures
85V/60Hz	221	17	57	Fig. 19
115V/50Hz	265	21	65	-
230V/50Hz	429	37	119	-
264V/60Hz	484	42	129	Fig. 22





5.2.3 Output Ripple & Noise

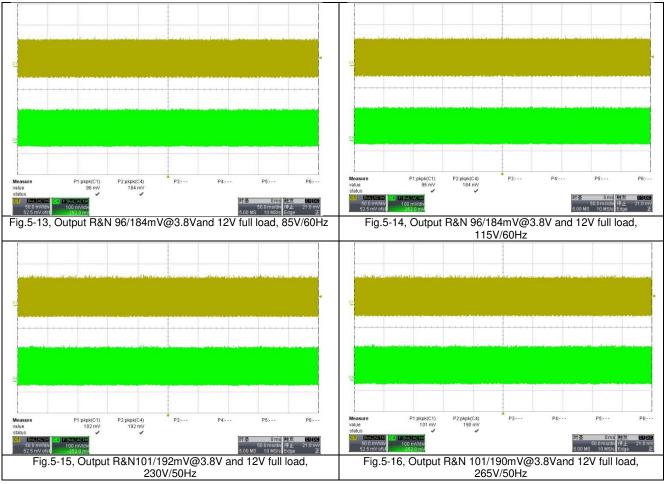
The ripple and noise was tested at PCB terminal, using coaxial cable (1:1). The bandwidth was limited to 20MHz. A 10uF electrolytic capacitor and a 104 ceramic capacitor should be paralleled to the output terminal.

	Table 5-	7, ripple & noise		
Conditions	Input voltage	R&N(mV)		Figures
Conditions	input voltage	Vo1 terminal	Vo2 terminal	
	85V/60Hz	96	184	Fig. 23
3.8V full load, 12V full load	115V/50Hz	96	184	-
, , , , , , , , , , , , , , , , , , ,	230V/50Hz	101	192	-
	264V/60Hz	101	190	Fig. 24

CH1:Vo1 output; CH4:Vo2 output



Dual Output Off-Line Non-isolated Flyback Power Solution AP3917B 12V/20mA+3.8V20mA EV3 Board User's Guide

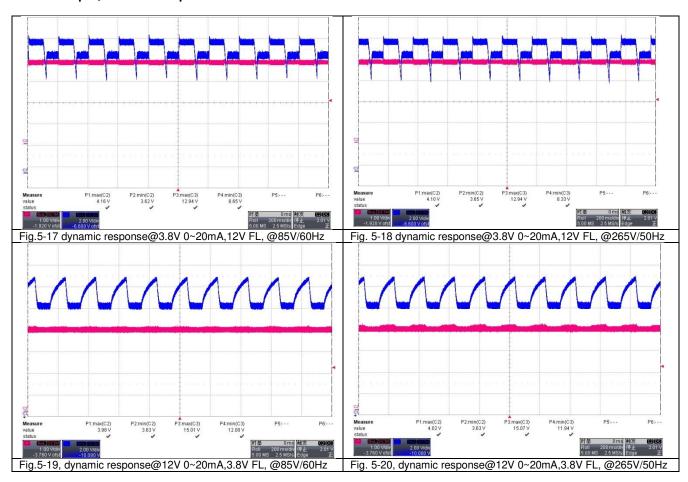


5.2.4 Dynamic Response

The dynamic response output voltage was tested at the PCB terminal, and the bandwidth was limited to 20MHz. The loading is set 0mA as low load and 20mA as high load, and last for 0.1s respectively. The ramp is set at 40mA/us.

		Output voltage(V)				
Conditions	Vin	Vo1		Vo2		Figures
		Max (V)	Min (V)	Max (V)	Min (V)	Ŭ
12V full load,	85V/60Hz	4.16	3.62	12.94	8.65	Fig. 27
3.8V loading	115V/60Hz	4.10	3.65	12.87	8.52	-
0~100%	230V/50Hz	4.06	3.65	12.87	8.71	-
	264V/50Hz	4.10	3.65	12.94	8.31	Fig. 28
3.8V full load,	85V/60Hz	3.98	3.63	15.01	12.00	Fig. 29
12V loading	115V/60Hz	3.95	3.63	15.01	11.94	-
0~100%	230V/50Hz	4.02	3.63	15.01	11.94	-
	264V/50Hz	4.02	3.63	15.07	11.94	Fig. 30





5.3 Protection (SCP) test

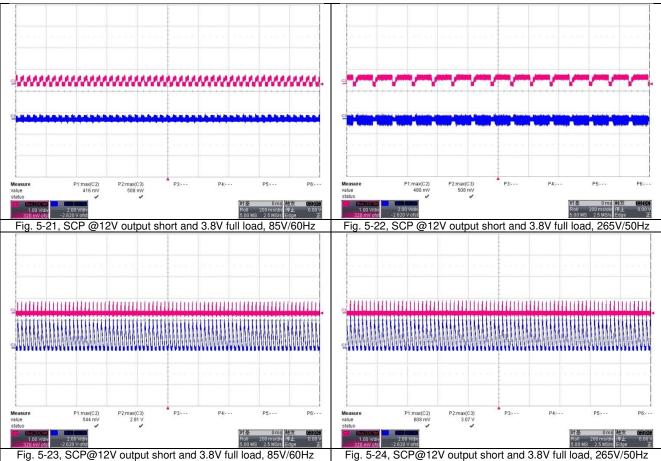
The SCP test was measured under the condition of output cable terminal short circuit.

Table 5-9	, the short	circuit	protection test
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Condition	Vin	Vo1 max(V)	Vo2 max(V)	Figures
	85V/60Hz	0.416	0.508	Fig. 31
12V terminal output short	115V/60Hz	0.425	0.512	-
	230V/50Hz	0.463	0.503	-
	264V/50Hz	0.480	0.508	Fig. 32
	85V/60Hz	0.544	2.81	Fig. 33
3.8V terminal output short	115V/60Hz	0.562	2.90	-
	230V/50Hz	0.588	3.05	-
	264V/50Hz	0.608	3.07	Fig. 34

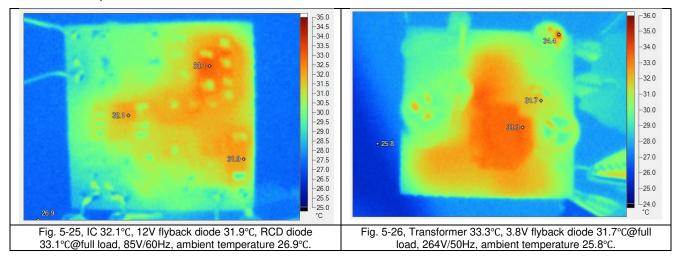
CH2:3.8V output; CH3:12V output





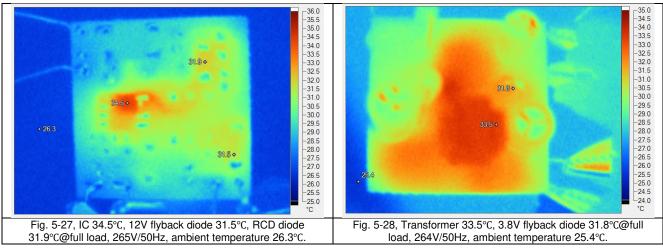
5.4 Thermal Test

The thermal test was under room temperature after burning 1 hour. The board has no case, and using thermal imager to observe the surface temperature of IC.





Dual Output Off-Line Non-isolated Flyback Power Solution AP3917B 12V/20mA+3.8V20mA EV3 Board User's Guide

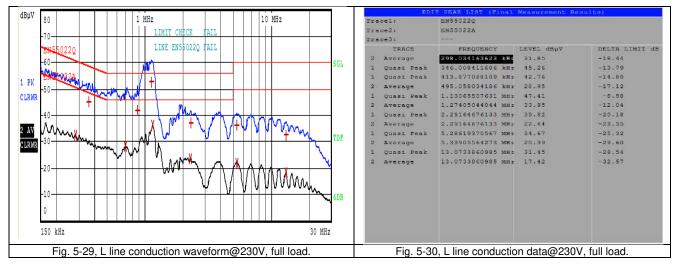


5.5 System EMI Scan

The power supply passed EN55022 Class B (for 230V input) and FCC part 15 (for 110V input) EMI requirement with more than 6dB margin.

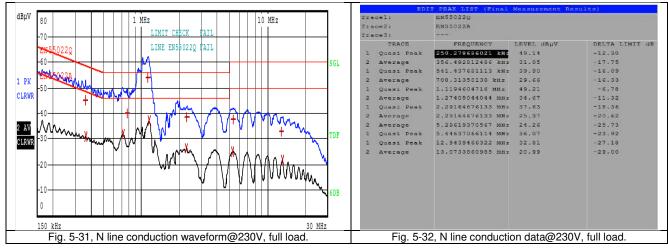
5.5.1 Conduction EMI test of 230V@full load

The test result can pass EN55022 Class B limitation with more than 6dB margin.

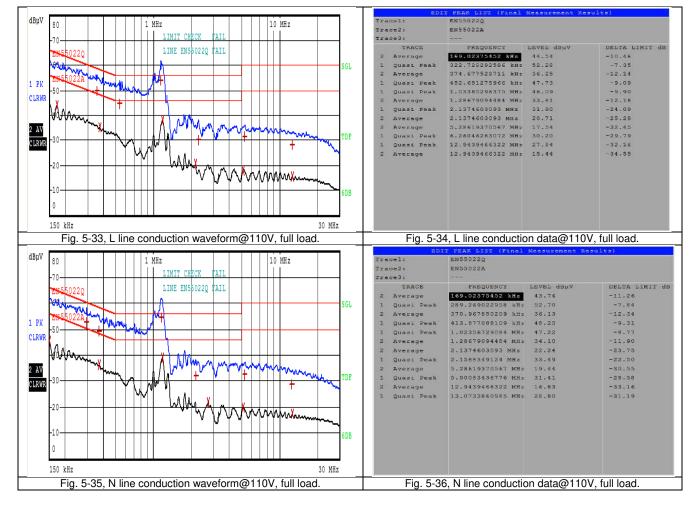




Dual Output Off-Line Non-isolated Flyback Power Solution AP3917B 12V/20mA+3.8V20mA EV3 Board User's Guide



5.5.2 Conduction EMI test of 110V@full load



The test result can pass FCC part 15 limitation with more than 6dB margin.



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